

STB20NM60D

N-channel 600V - 0.26Ω - 20A - D²PAK FDmesh™ Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D	Pw
STB20NM60D	600V	<0.29Ω	20A	45W

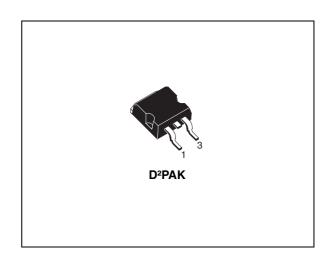
- High dv/dt and avalanche capabilities
- 100% Avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance
- Tight process control and high manufacturing yields

Description

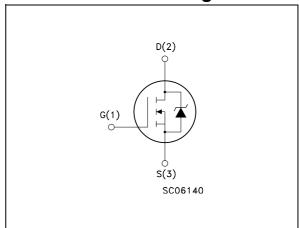
The FDmesh™ associates all advantages of reduced on-resistance and fast switching with an intrinsic fast-recovery body diode. It is therefore strongly recommended for bridge topologies, in particular ZVS phase-shift converters.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Marking Package	
STB20NM60D	B20NM60D	D ² PAK	Tape & reel

Contents STB20NM60D

Contents

1	Electrical ratings	. 3
2	Electrical characteristics	
3	Test circuit	
4	Package mechanical data	. 9
5	Packaging mechanical data	11
6	Revision history	12

STB20NM60D Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	600	٧
V _{DGR}	Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	600	٧
V _{GS}	Gate- source voltage	± 30	٧
I _D	Drain current (continuous) at T _C = 25°C	20	Α
I _D	Drain current (continuous) at T _C = 100°C	12.6	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	80	Α
P _{TOT}	Total dissipation at T _C = 25°C	192	W
	Derating factor	1.20	W/°C
dv/dt (2)	Peak diode recovery voltage slope	20	V/ns
T _j T _{stg}	Operating junction temperature Storage temperature	- 65 to 150	°C

^{1.} Pulse width limited by safe operating area

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case Max	0.65	°C/W
Rthj-amb	Thermal resistance junction-ambient Max	62.5	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Table 3. Avalanche data

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_j max)	10	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 35$ V)	700	mJ

5/

^{2.} $I_{SD} \le 20A$, $di/dt \le 400A/\mu s$, $V_{DD} = 80\%V_{(BR)DSS}$

Electrical characteristics STB20NM60D

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Parameter Test condictions			Max	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	600			V
lana	Zero gate voltage	V _{DS} = Max rating			1	μΑ
I _{DSS}	drain current (V _{GS} = 0)	$V_{DS} = Max rating, T_C = 125 °C$			10	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	$V_{GS} = \pm 30V$			±10 0	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 10A		0.26	0.29	Ω

Table 5. Dynamic

Symbol	Parameter	Test condictions	Min	Тур	Max	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max},$ $I_{D} = 10A$		9		S
C _{iss}	Input capacitance			1300		pF
Coss	Output capacitance	$V_{DS} = 25V, f = 1 \text{ MHz}, V_{GS} = 0$		500		pF
C_{rss}	Reverse transfer capacitance			35		pF
C _{oss eq.} (2)	Equivalent output capacitance	$V_{GS} = 0V, V_{DS} = 0V \text{ to } 480V$		190		pF
R_{G}	Gate input resistance	f=1 MHz Gate DC Bias = 0 Test signal level = 20mV open drain		2.7		Ω
Q_{g}	Total gate charge	$V_{DD} = 480V, I_{D} = 20A,$		37	52	nC
Q_{gs}	Gate-source charge	V _{GS} = 10V		10		nC
Q_{gd}	Gate-drain charge	(see Figure 13)		17		nC

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5 %

^{2.} $C_{\rm oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as $C_{\rm oss}$ when $V_{\rm DS}$ increases from 0 to 80%

Table 6. Switching times

Symbol	Parameter	Test condictions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	$V_{DD} = 300V$, $I_D = 10A$ $R_G = 4.7\Omega V_{GS} = 10V$ (see Figure 12)		25 12		ns ns
t _{r(Voff)} t _f t _c	Off-voltage rise time Fall time Cross-over time	$V_{DD} = 480 \text{ V}, I_D = 20\text{A}, \\ R_G = 4.7\Omega, V_{GS} = 10\text{V} \\ \text{(see Figure 12)}$		8 22 30		ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test condictions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				20 80	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 20 A, V _{GS} = 0			1.5	V
t _{rr}	Reverse recovery time	I _{SD} = 20 A, T _i = 25°C		240		ns
Q_{rr}	Reverse recovery charge	di/dt =100A/µs,V _{DD} =60V		1800		nC
I _{RRM}	Reverse recovery current	(see Figure 17)		16		Α
t _{rr}	Reverse recovery time	I _{SD} = 20 A, T _j = 150°C		396		ns
Q_{rr}	Reverse recovery charge	di/dt =100A/µs,V _{DD} =60V		2960		nC
I _{RRM}	Reverse recovery current	(see Figure 17)		20		Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5 %.

Electrical characteristics STB20NM60D

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

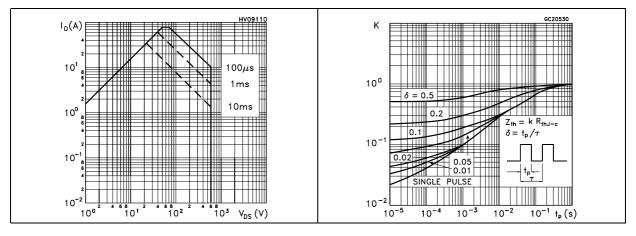


Figure 3. Output characterisics

Figure 4. Transfer characteristics

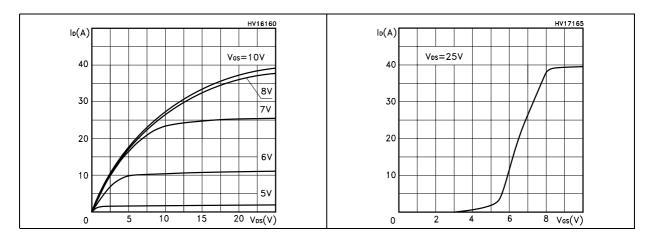
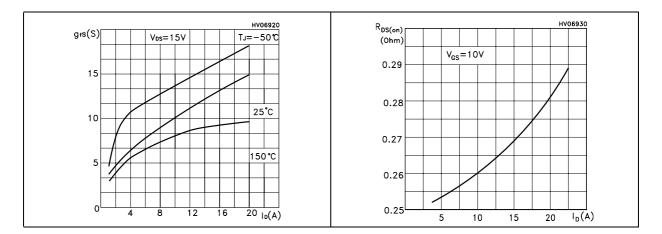


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



577

Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

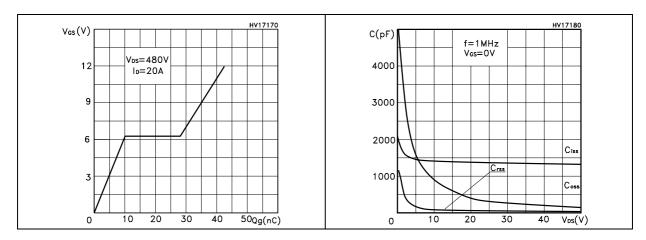


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs vs temperature temperature

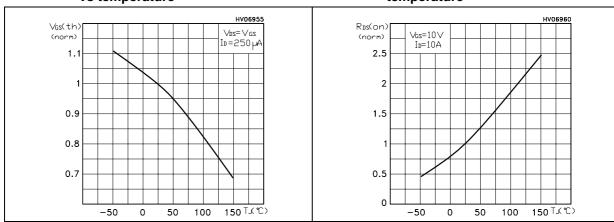
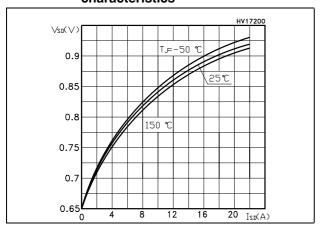


Figure 11. Source-drain diode forward characteristics



47/

Test circuit STB20NM60D

3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

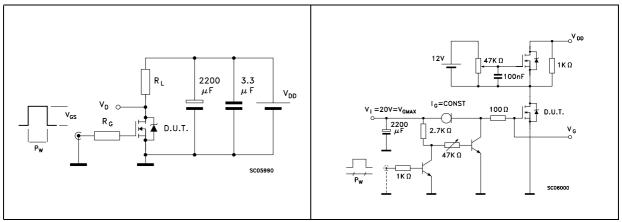


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped inductive load test circuit

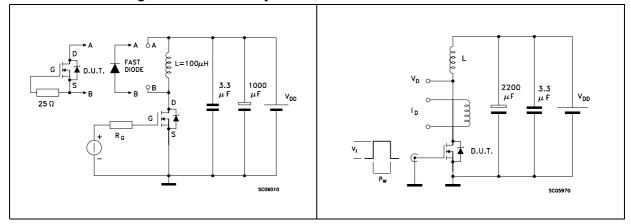
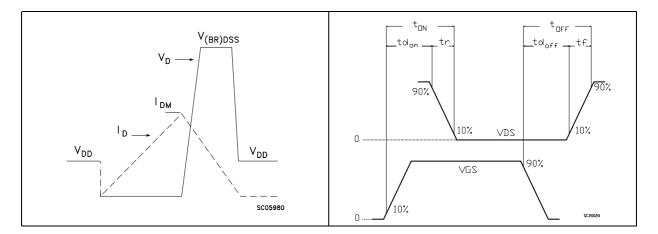


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform



577

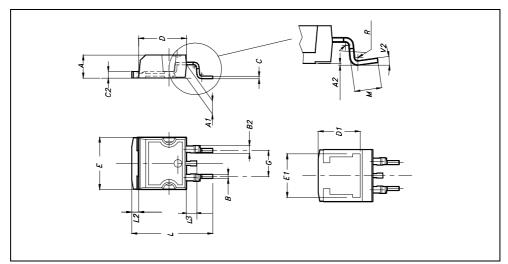
4 Package mechanical data

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9/13

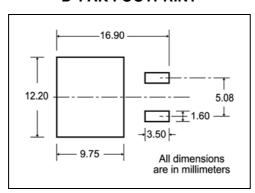
D²PAK MECHANICAL DATA

DIM		mm.		inch		
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
В	0.7		0.93	0.027		0.036
B2	1.14		1.7	0.044		0.067
С	0.45		0.6	0.017		0.023
C2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1		8			0.315	
E	10		10.4	0.393		
E1		8.5			0.334	
G	4.88		5.28	0.192		0.208
L	15		15.85	0.590		0.625
L2	1.27		1.4	0.050		0.055
L3	1.4		1.75	0.055		0.068
М	2.4		3.2	0.094		0.126
R		0.4			0.015	
V2	0₀		4º			

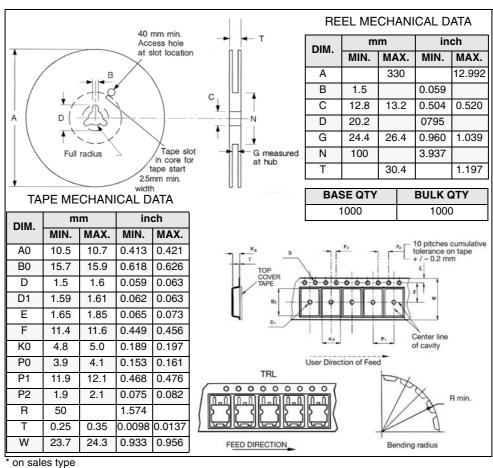


Packaging mechanical data 5

D²PAK FOOTPRINT



TAPE AND REEL SHIPMENT



Revision history STB20NM60D

6 Revision history

Table 8. Revision history

Date	Revision	Changes
08-Jun-2006	1	First release

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